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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO
10/697,744	10/30/2003	Willi Recktenwald	DE920010027US2	8782
. 7590 09/16/2005		EXAMINER		
Floyd A. Gonz	zalez		PHAN, THIEM D	
IBM Corporatio	on		ART UNIT	PAPER NUMBER
2455 South Roa	ıd		3729	
Poughkeepsie, NY 12601			DATE MAILED: 09/16/200	5

Please find below and/or attached an Office communication concerning this application or proceeding.

•		Si C)
	Application No.	Applicant(s)	
	10/697,744	RECKTENWALD ET AL.	
Office Action Summary	Examiner	Art Unit	
	Tim Phan	3729	
The MAILING DATE of this communicate Period for Reply	ation appears on the cover sheet w	ith the correspondence address	
A SHORTENED STATUTORY PERIOD FOR WHICHEVER IS LONGER, FROM THE MAIN - Extensions of time may be available under the provisions of after SIX (6) MONTHS from the mailing date of this communer. If NO period for reply is specified above, the maximum statuter. Failure to reply within the set or extended period for reply with Any reply received by the Office later than three months after earned patent term adjustment. See 37 CFR 1.704(b).	LING DATE OF THIS COMMUNI 37 CFR 1.136(a). In no event, however, may a ication. ory period will apply and will expire SIX (6) MOI 1, by statute, cause the application to become A	CATION. reply be timely filed VTHS from the mailing date of this communication. BANDONED (35 U.S.C. § 133).	
Status			
1) Responsive to communication(s) filed	on <u>10/30/03</u> .		
·— ·)⊠ This action is non-final.	·	
3) Since this application is in condition fo	r allowance except for formal mat	ters, prosecution as to the merits is	
closed in accordance with the practice	under <i>Ex parte Quayle</i> , 1935 C.I). 11, 453 O.G. 213.	
Disposition of Claims			
4) Claim(s) 1 and 2 is/are pending in the	application.		
4a) Of the above claim(s) is/are	withdrawn from consideration.		
5) Claim(s) is/are allowed.			
6)⊠ Claim(s) <u>1 and 2</u> is/are rejected.			
7) Claim(s) is/are objected to.			
8) Claim(s) are subject to restriction	on and/or election requirement.		
Application Papers			
9)⊠ The specification is objected to by the		·	
10) The drawing(s) filed on is/are: a			
Applicant may not request that any objecti			
Replacement drawing sheet(s) including the			
11)☐ The oath or declaration is objected to t	by the Examiner. Note the attache	d Office Action of form F10-132.	
Priority under 35 U.S.C. § 119			
12)⊠ Acknowledgment is made of a claim fo	r foreign priority under 35 U.S.C.	§ 119(a)-(d) or (f).	٠
a)⊠ All b)□ Some * c)□ None of:			
 Certified copies of the priority de 		·	
·	ocuments have been received in a		
3. Copies of the certified copies of		received in this National Stage	
application from the Internation			
* See the attached detailed Office action	tor a list of the certified copies no	received.	
Attachment(s)			

1) Notice of References Cited (PTO-892)

Paper No(s)/Mail Date <u>10/30/03</u>.

2) Notice of Draftsperson's Patent Drawing Review (PTO-948)

3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)

4) Interview Summary (PTO-413)

6) Other: _

Paper No(s)/Mail Date. _____.

5) Notice of Informal Patent Application (PTO-152)

Art Unit: 3729

DETAILED ACTION

Title

1. The following title is suggested: "Method for Adjusting the ESR of multilayer component".

Abstract

2. Applicants are reminded of the proper language and format for an abstract of the disclosure.

The abstract should be in narrative form and generally limited to a single paragraph on a separate sheet within the range of 50 to 150 words. It is important that the abstract not exceed 150 words in length since the space provided for the abstract on the computer tape used by the printer is limited. The form and legal phraseology often used in patent claims, such as "means" and "said," should be avoided. The abstract should describe the disclosure sufficiently to assist readers in deciding whether there is a need for consulting the full patent text for details.

The language should be clear and concise and should not repeat information given in the title. It should avoid using phrases which can be implied, such as, "The disclosure concerns," "The disclosure defined by this invention," "The disclosure describes," etc.

Currently, the Abstract has 174 words counted. Appropriate correction is required.

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Claim Rejections - 35 USC § 102

3. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 4. Claims 1 and 2 are rejected under 35 U.S.C. 102(b) as being anticipated by Rieb et al (US 5,692,917).

As applied to claim 1, Rieb et al teach a process of selectively making electrical connection within communication I/O port to protect computer software, comprising:

- forming a laminate base structure or connection (Fig. 1, 20) having plated through holes
 (Fig. 1, 22) for introducing press-fit elements,
- forming a laminate cover structure of printed circuit board (Fig. 1, 28; col. 3, lines 39-41) providing very fine conducting paths and having a top mounting plane for mounting chips (Fig. 7, 94; col. 6, lines 1-5) on a substrate or printed circuit board, and
- forming a hybrid structure (Fig. 1, 10) comprised of said laminate surface structure or connection (Fig. 1, 20 & 24) and said laminate cover structure (Fig. 1, 28).

As applied to claim 2, Rieb et al teach a process of selectively making electrical connection within communication I/O port to protect computer software, comprising:

- forming a laminate base structure or connection (Fig. 1, 20) having plated through holes (Fig. 1, 22) for introducing press-fit elements,
- forming a laminate cover structure of printed circuit board (Fig. 1, 28; col. 3, lines 39-41) providing very fine conducting paths and having a top mounting plane for mounting chips (Fig. 7, 94; col. 6, lines 1-5) on a substrate or printed circuit board, and
- forming a sandwich structure (Fig. 1, 10) being comprised of said laminate surface structure or connection (Fig. 1, 20 & 24) and said laminate cover structure (Fig. 1, 28), whereby said structures are subsequently mechanically and electrically conductive connected to each other for transferring data signals (Col. 3, lines 43-45).

Conclusion

5. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Tim Phan whose telephone number is 571-272-4568. The examiner can normally be reached on M - F, 9AM - 5PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Peter Vo can be reached on 571-272-4690. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent

Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Tim Phan Examiner Art Unit 3729

September 13, 2005

A. DEXTER TUGBANG PRIMARY EXAMINED